



Express Mail Label No. EV443088782US

PATENT APPLICATION
Docket No. 11675.184.1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re application of | |) | |
| | Salman Akram |) | |
| Serial No. | 10/033,233 |) | |
| Filed: | December 28, 2001 |) | Art Unit |
| | |) | 2823 |
| For: | CHIP PACKAGE WITH GREASE HEAT SINK AND METHOD OF MAKING |) | |
| Confirmation No.: | 9685 |) | |
| Examiner: | Khiem D. Nguyen |) | |

AMENDMENT AND RESPONSE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated December 15, 2003, please enter the following amendments and remarks into the file of the above-identified application.